NEWPORT CORP Form 10-K March 11, 2008

UNITED STATES SECURITIES AND EXCHANGE COMMISSION Washington, DC 20549

FORM 10-K

(Mark One)

þ ANNUAL REPORT PURSUANT TO SECTION 13 OR 15(d) OF THE SECURITIES EXCHANGE ACT OF 1934

For the fiscal year ended December 29, 2007

OR

O TRANSITION REPORT PURSUANT TO SECTION 13 OR 15(d) OF THE SECURITIES EXCHANGE ACT OF 1934

For the transition period from ______ to _____

Commission File Number: 000-01649

NEWPORT CORPORATION

(Exact name of registrant as specified in its charter)

Nevada

94-0849175

(State or other jurisdiction of incorporation or organization)

(IRS Employer Identification No.)

1791 Deere Avenue, Irvine, California 92606

(Address of principal executive offices) (Zip Code)

Registrant s telephone number, including area code: (949) 863-3144

Securities registered pursuant to Section 12(b) of the Act:

Title of Each Class

Name of Each Exchange on Which Registered

Common Stock, Par Value \$0.1167 per share

The NASDAQ Stock Market LLC

Securities registered pursuant to Section 12(g) of the Act: None

Indicate by check mark if the registrant is a well-known seasoned issuer, as defined in Rule 405 of the Securities Act. Yes o No b

Indicate by check mark if the registrant is not required to file reports pursuant to Section 13 or Section 15(d) of the Act. Yes o No b

Indicate by check mark whether the registrant: (1) has filed all reports required to be filed by Section 13 or 15(d) of the Securities Exchange Act of 1934 during the preceding 12 months (or for such shorter period that the registrant was required to file such reports), and (2) has been subject to such filing requirements for the past 90 days. Yes β No o Indicate by check mark if disclosure of delinquent filers pursuant to Item 405 of Regulation S-K is not contained herein, and will not be contained, to the best of registrant s knowledge, in definitive proxy or information statements incorporated by reference in Part III of this Form 10-K or any amendment to this Form 10-K. o Indicate by check mark whether the registrant is a large accelerated filer, an accelerated filer, a non-accelerated filer, or a smaller reporting company. See the definitions of large accelerated filer, accelerated filer and smaller reporting company in Rule 12b-2 of the Exchange Act. (Check one):

Large accelerated filer o Accelerated filer b

Non-accelerated filer o (Do not check if a smaller reporting company) Smaller reporting company o Indicate by check mark whether the registrant is a shell company (as defined in Rule 12b-2 of the Act). Yes o No b As of June 30, 2007, the aggregate market value of the common stock held by non-affiliates of the registrant was approximately \$585.3 million, calculated based upon the closing price of the registrant s common stock as reported by the NASDAQ Global Market on such date.

As of March 5, 2008, 35,937,226 shares of the registrant s sole class of common stock were outstanding.

DOCUMENTS INCORPORATED BY REFERENCE

Portions of the registrant s Proxy Statement for its Annual Meeting of Stockholders to be held on May 20, 2008 are incorporated by reference into Part III of this Annual Report on Form 10-K.

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This Annual Report on Form 10-K contains certain forward-looking statements within the meaning of Section 27A of the Securities Act of 1933 and Section 21E of the Securities Exchange Act of 1934, and we intend that such forward-looking statements be subject to the safe harbors created thereby. For this purpose, any statements contained in this Annual Report on Form 10-K except for historical information may be deemed to be forward-looking statements. Without limiting the generality of the foregoing, words such as may, will, expect, believe, anticipate, intend, could, would, estimate, or continue or the negative or other variations thereof or comparable terminolog intended to identify forward-looking statements. In addition, any statements that refer to projections of our future financial performance, trends in our businesses, or other characterizations of future events or circumstances are forward-looking statements.

The forward-looking statements included herein are based on current expectations of our management based on available information and involve a number of risks and uncertainties, all of which are difficult or impossible to predict accurately and many of which are beyond our control. As such, our actual results may differ significantly from those expressed in any forward-looking statements. Factors that may cause or contribute to such differences include, but are not limited to, those discussed in more detail in Item 1 (Business) and Item 1A (Risk Factors) of Part I and Item 7 (Management s Discussion and Analysis of Financial Condition and Results of Operations) of Part II of this Annual Report on Form 10-K. Readers should carefully review these risks, as well as the additional risks described in other documents we file from time to time with the Securities and Exchange Commission. In light of the significant risks and uncertainties inherent in the forward-looking information included herein, the inclusion of such information should not be regarded as a representation by us or any other person that such results will be achieved, and readers are cautioned not to place undue reliance on such forward-looking information. We undertake no obligation to revise the forward-looking statements contained herein to reflect events or circumstances after the date hereof or to reflect the occurrence of unanticipated events.

PART I

Item 1. Business

General Description of Business

We are a global supplier of advanced technology products and systems to a wide range of industries, including scientific research, microelectronics, aerospace and defense/security, life and health sciences, and industrial manufacturing. We provide a broad portfolio of products to customers in these end markets, allowing us to offer them an end-to-end resource for products that make, manage and measure light.

As the demands of research and commercial applications for higher precision and miniaturization continue to increase, photonics, the science and technology of making, managing and measuring light, has become a key enabling technology, permitting researchers and commercial users to perform tasks that cannot be accomplished by existing electrical, mechanical or chemical processes. In addition, in markets such as microelectronics and life and health sciences, photonics technology is replacing these current processes in a number of applications it can accomplish faster, better or more economically.

We provide a wide range of products designed to enhance the capabilities and productivity of our customers photonics and other precision applications, including:

lasers and laser technology, including solid-state, gas and dye lasers, high-power diode lasers, fiber lasers and amplifiers, and ultrafast laser systems;

optical components and subassemblies, including precision optics and opto-mechanical subassemblies, thin-film optical filters, ruled and holographic diffraction gratings and crystals;

photonics instruments and components, including optical meters, light sources, monochromators and spectroscopy instrumentation;

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high-precision positioning and vibration isolation products and systems; and

advanced automated manufacturing systems used in the manufacture of communications and electronics devices.

In addition to our individual product offerings, we have significant expertise in integrating our products into systems and subsystems that are engineered to meet our customers—specific application requirements. We believe that our ability to develop and manufacture these integrated solutions, together with our broader portfolio of products and technologies, gives us a significant competitive advantage over our competitors.

For over four decades, we have serviced the needs of research laboratories for precision equipment. We have acquired a number of companies, which has led to the expansion of our product offerings, technology base and geographic presence and has allowed us to evolve from a provider of discrete components and instruments primarily for research applications to a company that manufactures both components and integrated systems for both research and commercial applications.

In February 2002, we acquired Micro Robotics Systems, Inc. (MRSI), a manufacturer of high-precision, fully-automated assembly and dispensing systems for back-end packaging applications in the semiconductor, microwave communications and fiber optic communications industries. MRSI has significant expertise in the design and manufacture of automated high-precision manufacturing systems. During the past two years, MRSI has focused its development efforts on automated laser-based manufacturing systems, particularly for disk drive and photovoltaic module manufacturing applications. MRSI is now part of our Photonics and Precision Technologies (PPT) Division.

In July 2004, we acquired Spectra-Physics, Inc. and certain related entities (collectively, Spectra-Physics). This acquisition significantly increased the scope of our expertise and product offerings in our target customer end markets, adding to our product portfolio solid-state, gas and dye lasers, high-power diode lasers, and ultrafast laser systems, as well as photonics instruments and components, including light sources, monochromators, spectroscopy instrumentation, optical filters, ruled and holographic diffraction gratings and crystals. This acquisition approximately doubled our size with respect to revenue, number of employees and facilities. At the time of the acquisition, we established Spectra-Physics laser and laser-related technology business as our Lasers Division, and we combined Spectra-Physics photonics businesses with the existing businesses that comprised our former Industrial and Scientific Technologies Division to create our PPT Division.

Following the acquisition of Spectra-Physics, we conducted a strategic review of all of our businesses and concluded that our robotic systems operations in Richmond, California, which served the front-end semiconductor equipment industry with product lines including wafer-handling robots, load ports and equipment front-end modules, were no longer core to our overall strategy. Consequently, in the first quarter of 2005, our Board of Directors approved a plan to sell these operations. At that time, we classified our robotic systems operations as discontinued operations. We completed the sale of these operations in December 2005. The robotic systems operations represented a substantial portion of our former Advanced Packaging and Automation Systems (APAS) Division. As a result of our decision to divest these operations, we realigned our business segments to include all remaining operations of our former APAS Division within our PPT Division. Accordingly, our operations are now conducted through two divisions, our Lasers Division and our PPT Division.

We will continue to pursue acquisitions of companies, technologies and complementary product lines that we believe will further our strategic objectives. Conversely, from time to time, we review our different businesses, including our acquired companies, to ensure that they are key to our strategic plans, and close or divest businesses that we determine are no longer of strategic importance. See Item 7, Management s Discussion and Analysis of Financial Condition and Results of Operations Overview, beginning on page 35, and Notes 2 and 3 of the Notes to Consolidated Financial Statements beginning on page F-13 of this Annual Report on Form 10-K.

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Our Markets

We sell our products, subsystems and systems to original equipment manufacturer (OEM) and end-user customers across a wide range of markets and applications, including:

Scientific Research. We are one of the world s leading suppliers of lasers and photonics products to scientific researchers. For more than forty-five years, we have worked closely with the research community to pioneer new applications and technologies. Today, we continue to help researchers break new ground in a variety of scientific research areas, including spectroscopy, ultrafast phenomena, multiphoton microscopy, terahertz imaging, optical coherence tomography, laser induced fluorescence, light detection and ranging (LIDAR) and nonlinear optics.

Microelectronics. Photonics technology addresses a number of vital applications in the microelectronics market, and is a key enabler of the industry roadmap driving smaller feature sizes with the increased functionalities needed for next-generation consumer technology products, including cellular phones, personal digital assistants and digital cameras. Our products are used in several key applications in this market, including semiconductor wafer inspection and metrology, memory yield enhancement, lithography, wafer dicing and scribing, wafer and component marking and resistor trimming, as well as in disk drive, printed circuit board, flat panel display and photovoltaic module manufacturing applications.

Life and Health Sciences. Photonics is increasingly becoming a key enabling technology in the life and health sciences market. We provide products for use in diagnostic and analytical instrumentation and cosmetic and therapeutic applications. Our products are used in applications such as optical coherence tomography, multiphoton and confocal microscopy, flow cytometry, matrix-assisted laser desorption/ionization time-of-flight (MALDI-TOF) mass spectrometry, laser microdissection, DNA microarrays and blood analysis to enable advancements in the fields of molecular biology, proteomics and drug discovery. In addition, we supply high-power diode lasers to OEM customers for incorporation into laser systems for hair removal and a variety of dermatological and dental procedures.

Aerospace and Defense/Security. The drive for more technologically advanced weapons and sensors is producing increased investment in light-based technologies that can remotely, rapidly and non-invasively detect threats, improve intelligence gathering, provide secure communications systems and improve the performance of weapons and countermeasures. In addition, innovative optical sensors are augmenting human vision on the battlefield, providing remote sensing, ranging and observation capabilities that offer high-resolution imaging and night vision. Our high-precision products are used by aerospace and defense engineers to develop, assemble, test and calibrate equipment for a wide range of applications, including target recognition and acquisition, LIDAR, range finding, missile guidance and advanced weapons development.

Industrial Manufacturing, Marking and Engraving. Our lasers and photonics products are used in a wide range of precision industrial manufacturing applications, including rapid prototyping, micromachining, heat-treating, welding and soldering, cutting, illumination, drilling and high-precision marking and engraving. We also offer laser solutions for image recording and graphics applications including pre-press (computer-to-plate), on-press, ultra-high speed printing, photo finishing and holography.

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Our Operating Divisions

We operate our business in two divisions, our Lasers Division and our PPT Division, which are organized around our primary product categories.

Lasers Division

Our Lasers Division, which was formed in July 2004 in connection with our acquisition of Spectra-Physics, offers a broad portfolio of laser technology products and services to OEM and end-user customers across a wide range of markets and applications. Our lasers and laser-based systems include ultrafast lasers and amplifiers, diode-pumped solid-state lasers, diode lasers, high-energy pulsed lasers, tunable lasers, gas lasers, and fiber lasers and amplifiers. We have established close relationships with OEM customers involved in microelectronics, life and health sciences and industrial manufacturing. In addition to supplying our existing lasers and laser systems to these customers, we also work closely with our OEM and industrial customers to develop laser and laser system designs optimized for their product and technology roadmaps. We offer our end-user customers a full range of laser technology solutions and accessories.

Products

The following table summarizes our primary laser and laser-based system product offerings by product category, and includes representative applications for each category:

Category	Products	Representative Applications
Ultrafast Lasers and Systems	Mai Tai® one box femtosecond	Femtosecond spectroscopy
	Ti:sapphire lasers	Materials processing
	Tsunami® ultrafast Ti:sapphire	Multiphoton microscopy
	lasers	Optical coherence tomography
	Opal [®] femtosecond optical	Semiconductor metrology
	parametric oscillator (OPO)	Terahertz imaging
	Spitfire® Pro ultrafast	Time-resolved photoluminescence
	Ti:sapphire amplifier	-
	TOPAS automated ultrafast optical	
	parametric amplifier (OPA)	
	Solstice One Box Ultrafast	
	Amplifier	
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Category	Products	Representative Applications
Diode-Pumped Solid State	BL series low power lasers	Diamond processing
Q-Switched Lasers	V-series high-repetition lasers	Disk texturing
	Tristar high repetition rate UV laser	Laser microdissection
	Navigator lasers	Matrix-assisted laser
	HIPPO high-power lasers	desorption/ionization
	Pulseo high peak power UV laser	Memory yield enhancement systems
	Explorer low-power UV lasers Empower green/UV lasers	Microelectronics material processing
		Pump source for Ti:sapphire lasers
		Rapid prototyping
		Resistor trimming
		Sapphire scribing
		Silicon micromachining
		Solar cell manufacturing
		Wafer marking
Diode-Pumped Solid State	Millennia® Pro i/s CW lasers	Flow cytometry
Continuous Wave (CW) and	MG series CW solid state green lasers	Forensic investigations
Quasi-CW Lasers	Reveal CW forensic lasers	Image recording
	Centennia® CW thin-disk lasers	Laser cooling
	Excelsior low power CW lasers	Materials processing
	Vanguard quasi-CW solid state UV lasers	Optical trapping
	3900S and Matisse® CW tunable	Raman imaging
	Ti:sapphire lasers	Semiconductor wafer inspection
	Cyan compact low power CW lasers	and metrology
		Solar cell manufacturing
		Spectroscopy
		Ti:Sapphire pumping
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Category Diode Lasers	Products Open heatsink diode laser bars Multi-bar modules Fiber-coupled diode laser bars Fiber-coupled single emitter diodes Open heatsink single emitter diodes Integra industrial diode laser systems	Representative Applications Graphics and printing Hair removal Material heat treatment and processing Medical, therapeutic and cosmetic procedures Pump source for solid state and fiber lasers Soldering and welding
High Energy Pulsed Nd:YAG and Tunable Lasers	Quanta-Ray® PRO, LAB and PIV series pulsed Nd:YAG lasers Quanta-Ray® INDI series compact Nd:YAG lasers MOPO® series High Energy optical parametric oscillator (OPO) Tunable dye lasers	Flat-panel display manufacturing Laser ablation Laser cleaning LIDAR Mass spectrometry Particle imaging velocimetry combustion diagnostics Plastic and ceramic component marking Remote sensing Spectroscopy
Gas Lasers	Air-cooled argon ion lasers Water-cooled ion laser systems Nitrogen lasers	Confocal microscopy DNA sequencing Flow cytometry Laser doppler anemometry Raman spectroscopy Semiconductor wafer inspection Spectroscopy Holography Laser-doppler velocimetry Lithography Fluorescence immunoassay Matrix-assisted laser desorption/ionization

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Fiber Laser Business Group

During 2006, we established a Fiber Laser business group within our Lasers Division, which is engaged in the development of fiber laser and fiber amplifier technology. We introduced the first product from this group, the Pantera quasi-continuous wave mode-locked high-power ultraviolet laser, in the fourth quarter of 2007. The fiber laser and fiber amplifier products from this group incorporate our leading-edge capabilities in diode lasers, fiber coupling, frequency conversion, optics and photonics packaging.

Photonics and Precision Technologies Division

Our PPT Division s products and systems are used in applications across all of our target end markets. In addition, we sell subsystems to OEM customers that integrate our products into their systems, particularly for microelectronics and life and health sciences applications. The products sold by this division include photonics instruments and systems, precision micro-positioning systems and subsystems, vibration isolation systems and subsystems, optical hardware, opto-mechanical subassemblies and crystals. The PPT Division also offers automated systems and subsystems for advanced applications in the manufacturing of communications and electronic devices, including disk drives, photovoltaic cells and microwave, optical, radio frequency (RF) and multi-chip modules. *Products*

The following table summarizes our PPT Division s primary product offerings by product category, and includes representative applications for each category:

Category	Products	Representative Applications
Photonics Instruments and Systems	Optical meters	Characterization of light
	Laser diode instruments	emitted by lasers, light emitting diodes
	Light sources	and broadband light sources
	Solar simulators	Chemical composition analysis
	Solar cell test instruments	Colorimetry
	Photonics test systems	Optical power and energy
	Optical detectors	measurement for free space and
	Dispersive and Fourier transform (FT)	fiber-directed laser light
	spectrometers	Solar cell characterization
	Monochromators and spectrographs	and measurements
	Ultrafast laser pulse measurement	Testing and characterization
	systems	of optical fibers and passive fiber optic
		components
		Spectroscopy
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Category	Products	Representative Applications
Precision Micro-Positioning	Precision air-bearing motion	High-precision positioning and
Devices,	systems	
Systems and Subsystems	Motorized linear and rotation stages	motion control apparatus for
	Motorized actuators and optics	manufacturing, in-process
	mounts	inspection and
	Custom multi-axis positioning systems	final test applications
	Motion controllers and drivers	High-precision positioning
	Manual linear and rotation stages	systems for thin-film solar panel
	Fiber alignment stages and accessories	manufacturing
	Micrometers and adjustment screws	Laser system alignment and
		beam steering for inspection, laser
		processing and communications
		Precision positioning of
		semiconductor wafers for
		metrology and
		fabrication Precision alignment in fiber
		optic, telecommunication and laser
		device
		assembly
		Sample or sensor manipulation
		for imaging and microscopy
		Sample sorting and sequencing for
		DNA research
		Tracking and targeting test
		systems for aerospace and
		defense/security
		applications
Vibration Isolation Systems and Subsystems	Optical tables and support systems	Foundation platforms for laser
·	Workstations	systems
	Active and passive isolation	Isolated platform for
	systems	
	Active vibration damping systems	semiconductor lithography equipment
	Honeycomb, granite and rigid	Reduction of impact of
	structures	external vibration sources on
	Elastomeric mounts	high-precision research,
		manufacturing
		test and assembly systems
		Scanning electron microscope,

atomic force microscope, and optical microscope base isolation Workstation platforms for fiber optic device fabrication Workstation platforms for microscopy and other advanced imaging applications

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Category	Products	Representative Applications
Optics and Optical Hardware	Lenses	Analytical instrumentation for
	Mirrors	life and health sciences
	Prisms and windows	Components for research and
	Thin-film filters and coatings	product development activities
	Filters and attenuators	Deep ultraviolet optics for
	Collimators	semiconductor lithography, wafer
	Ultrafast laser optics	inspection and wafer processing
	Beamsplitters and polarization optics	Development and manufacture of
	Ruled and holographic diffraction	laser systems
	gratings	Electro-optic sensors and
	Optical mounts	imaging systems for
	Optical mounts	defense/security
	Bases and brackets	applications
	Posts and rod systems	High-precision alignment of
	Beam routing and enclosing	optical instruments
	systems	-
	Laser-to-fiber couplers	Optical measurement and
	Educational kits	communications systems
		Spectroscopy
		Ultrafast laser, terahertz
		imaging and laser fusion research
Opto-Mechanical Subassemblies	Laser beam delivery and imaging	Analytical instrumentation for
and Subsystems	assemblies	life and health sciences
	Integrated electro-optic-mechanical	High-speed cell sorting for
	subsystems	genomic research
	Objective lens systems	Laser beam delivery systems
	Refractive beam shaper assemblies	for solar cell manufacturing
	Fast steering mirrors	Laser beam stabilization for
	Laser beam attenuators	industrial metrology
		Light detection and ranging
		Optical coherence tomography
		for non-invasive diagnostics
		Optical data storage
		Semiconductor mask patterning
		Semiconductor wafer defect
		inspection
		Thin-film measurement of
		semiconductor wafers
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Category	Products	Representative Applications
Crystals	Optical crystals	Infrared spectroscopy (FT-IR)
	Scintillation crystals	for quality assurance
	Crystal imaging arrays	Optical and acoustic
	Electro optics	applications including frequency doubling,
		optical modulators and Q switches
		X-ray detection such as steel
		thickness gauging
		X-ray imaging for security,
		industrial and medical applications
Advanced Manufacturing Systems	Automated manufacturing/ assembly	Automated manufacturing and
	systems	assembly of microelectronic and
	Automated dispensing systems	optoelectronic devices
		High-speed, high-accuracy
		automated dispensing applications
		for
		microwave modules, optical modules, hybrid
		circuits, multi-chip modules and
		circuits, main cimp inodules and